


IRK.F132.. SERIES

**FAST THYRISTOR/ DIODE and
THYRISTOR/THYRISTOR**

INT-A-pak™ Power Modules

Features

- Fast turn-off thyristor
- Fast recovery diode
- High surge capability
- Electrically isolated baseplate
- 3000 V_{RMS} isolating voltage
- Industrial standard package
- UL E78996 approved 

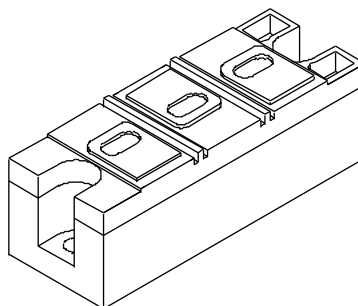
130 A

Description

These series of INT-A-pak modules are intended for applications such as self-commutated inverters, DC choppers, electronic welders, induction heating and others where fast switching characteristics are required.

Major Ratings and Characteristics

Parameters	IRK.F132..	Units
$I_{T(AV)}$	130	A
@ T_C	90	°C
$I_{T(RMS)}$	293	A
I_{TSM} @ 50Hz	3210	A
@ 60Hz	3360	A
I^2t @ 50Hz	51.5	KA ² s
@ 60Hz	47.0	KA ² s
$I^2\sqrt{t}$	515	KA ² √s
t_q	15	μs
t_{rr}	2	μs
V_{DRM}/V_{RRM}	up to 800	V
T_J range	-40 to 125	°C



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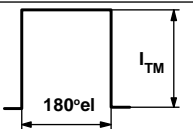
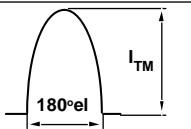
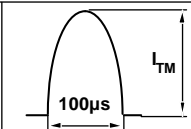
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ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{RRM}/V_{DRM} , maximum repetitive peak reverse voltage V	V_{RSM} , maximum non-repetitive peak rev. voltage V	I_{RRM}/I_{DRM} max. @ $T_J = 125^\circ\text{C}$ mA
IRK.F132..	04	400	400	30
	08	800	800	

Current Carrying Capacity

Frequency f							Units
50Hz	250	420	408	640	2465	3460	A
400Hz	320	530	485	800	1470	2150	A
2500Hz	240	390	400	650	540	830	A
5000Hz	210	340	340	530	340	530	A
10000Hz	160	275	300	415	-	-	A
Recovery voltage Vr	50	50	50	50	50	50	V
Voltage before turn-on Vd	80%V _{DRM}		80%V _{DRM}		80%V _{DRM}		V
Rise of on-state current di/dt	50	50	-	-	-	-	A/µs
Case temperature	90	60	90	60	90	60	°C
Equivalent values for RC circuit	47 Ω / 0.22 µF		47 Ω / 0.22 µF		47 Ω / 0.22 µF		

On-state Conduction

Parameter		IRK.F132..	Units	Conditions			
I _{T(AV)}	Maximum average on-state current @ Case temperature	130	A	180° conduction, half sine wave			
		90	°C				
I _{T(RMS)}	Maximum RMS current	293	A	T _C = 90°C, as AC switch			
I _{TSM}	Maximum peak, one-cycle, non-repetitive surge current	3210	A	t = 10ms	No voltage	Sinusoidal half wave, Initial T _J = 125°C	
		t = 8.3ms		reapplied			
		t = 10ms		100% V _{RRM}			
		t = 8.3ms		reapplied			
I ² t	Maximum I ² t for fusing	51.5	KA ² s	t = 10ms	No voltage		Initial T _J = 125°C
		47.0		t = 8.3ms	reapplied		
		36.5		t = 10ms	100% V _{RRM}		
		33.3		t = 8.3ms	reapplied		
I ² √t	Maximum I ² √t for fusing	515	KA ² √s	t = 0 to 10ms, no voltage reapplied			
V _{T(TO)1}	Low level value of threshold voltage	1.16	V	(16.7% × π × I _{T(AV)}) < I < π × I _{T(AV)} , T _J = T _J max.			
V _{T(TO)2}	High level value of threshold voltage	1.25		(I > π × I _{T(AV)}), T _J = T _J max.			
r _{t1}	Low level value of on-state slope resistance	0.92	mW	(16.7% × π × I _{T(AV)}) < I < π × I _{T(AV)} , T _J = T _J max.			
r _{t2}	High level value of on-state slope resistance	0.77		(I > π × I _{T(AV)}), T _J = T _J max.			
V _{TM}	Maximum on-state voltage drop	1.71	V	I _{pk} = 600A, T _J = T _J max., t _p = 10ms sine pulse			
I _H	Maximum holding current	600	mA	T _J = 25°C, I _T > 30 A			
I _L	Typical latching current	1000	mA	T _J = 25°C, V _A = 12V, R _a = 6Ω, I _g = 1A			

Switching

Parameter	IRK.F132..	Units	Conditions
di/dt Maximum non-repetitive rate of rise	800	A/μs	Gate drive 20V, 20Ω, tr ≤ 1ms, V _D = 80% V _{DRM} T _J = 25°C
t _{rr} Maximum recovery time	2	μs	I _{TM} = 350A, di/dt = -25A/μs, V _R = 50V, T _J = 25°C
t _q Maximum turn-off time	L	μs	I _{TM} = 350A, T _J = 125°C, di/dt = -25A/μs, V _R = 50V, dv/dt = 400V/μs linear to 80% V _{DRM}
	15		

Blocking

Parameter	IRK.F132..	Units	Conditions
dv/dt Maximum critical rate of rise of off-state voltage	1000	V/μs	T _J = 125°C., exponential to = 67% V _{DRM}
V _{INS} RMS isolation voltage	3000	V	50 Hz, circuit to base, T _J = 25°C, t = 1 s
I _{RRM} Maximum peak reverse and off-state leakage current I _{DRM}	30	mA	T _J = 125°C, rated V _{DRM} /V _{RRM} applied

Triggering

Parameter	IRK.F132..	Units	Conditions
P _{GM} Maximum peak gate power	60	W	f = 50 Hz, d% = 50
P _{G(AV)} Maximum peak average gate power	10	W	T _J = 125°C, f = 50Hz, d% = 50
I _{GM} Maximum peak positive gate current	10	A	T _J = 125°C, t _p ≤ 5ms
- V _{GM} Maximum peak negative gate voltage	5	V	
I _{GT} Max. DC gate current required to trigger	200	mA	T _J = 25°C, V _{ak} 12V, Ra = 6
V _{GT} DC gate voltage required to trigger	3	V	
I _{GD} DC gate current not to trigger	20	mA	T _J = 125°C, rated V _{DRM} applied
V _{GD} DC gate voltage not to trigger	0.25	V	

Thermal and Mechanical Specifications

Parameter	IRK.F132..	Units	Conditions
T _J Max. junction operating temperature range	- 40 to 125	°C	
T _{stg} Max. storage temperature range	- 40 to 150		
R _{thJC} Max. thermal resistance, junction to case	0.17	K/W	Per junction, DC operation
R _{thC-hs} Max. thermal resistance, case to heatsink	0.035	K/W	Mounting surface flat and greased Per module
T Mounting torque ± 10%	IAP to heatsink	4 - 6 (35 - 53)	A mounting compound is recommended. The torque should be rechecked after a period of 3 hours to allow for the spread of the compound. Use of cable lugs is not recommended, busbars should be used and restrained during tightening. Threads must be lubricated with a compound
	busbar to IAP	4 - 6 (35 - 53)	
wt Approximate weight	500 (17.8)	g (oz)	

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ΔR_{thJC} Conduction

(The following table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction	Rectangular conduction	Units	Conditions
180°	0.016	0.011	K/W	$T_J = 125^\circ\text{C}$
120°	0.019	0.020		
90°	0.024	0.026		
60°	0.035	0.037		
30°	0.060	0.060		

Ordering Information Table

Device Code									
IRK	T	F	13	2	-	08	H	L	N
①	②	③	④	⑤		⑥	⑦	⑧	⑧
1	- Module type								
2	- Circuit configuration								
3	- Fast SCR								
4	- Current rating: $I_{T(AV)} \times 10$ rounded								
5	- 1 = option with spacers and longer terminal screws 2 = option with standard terminal screws								
6	- Voltage code: Code $\times 100 = V_{RRM}$ (See Voltage Ratings Table)								
7	- dv/dt code: $H \leq 400\text{V}/\mu\text{s}$								
8	- t_q code: $L \leq 15\mu\text{s}$								
9	- None = Standard devices N = Aluminum nitride substrate								

NOTE: To order the Optional Hardware see Bulletin I27900

Outline Table

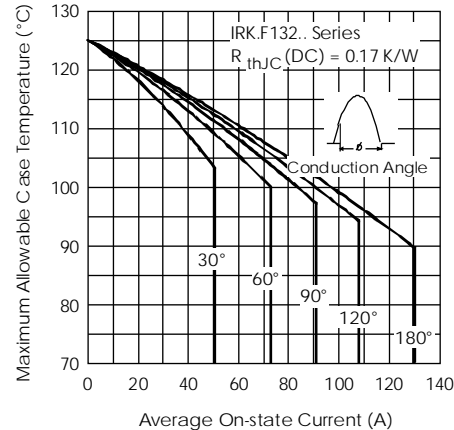
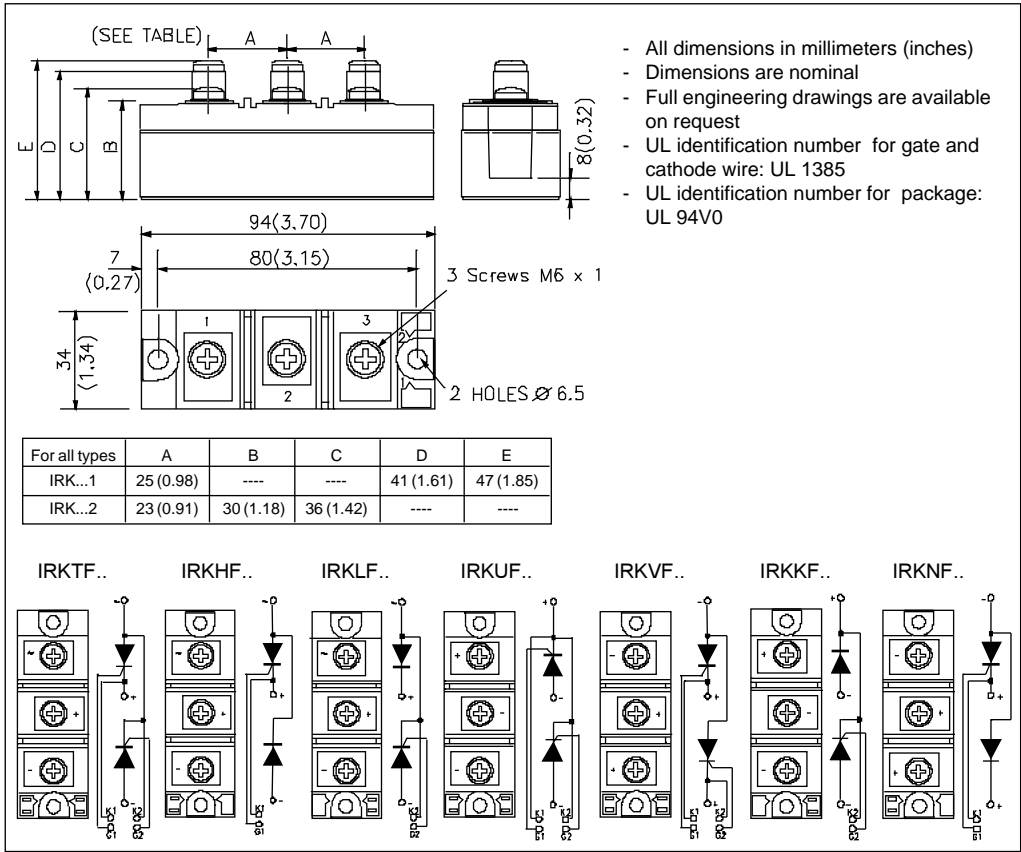


Fig. 1 - Current Ratings Characteristics

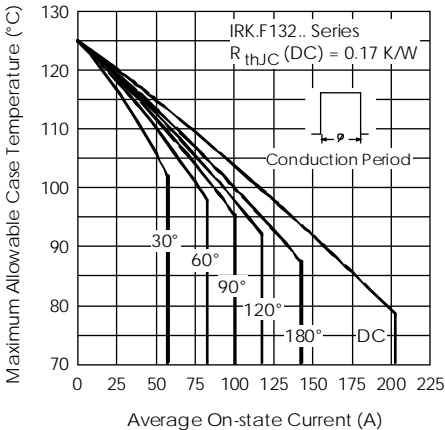


Fig. 2 - Current Ratings Characteristics

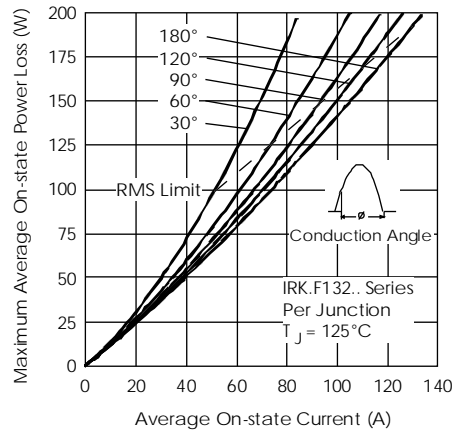


Fig. 3 - On-state Power Loss Characteristics

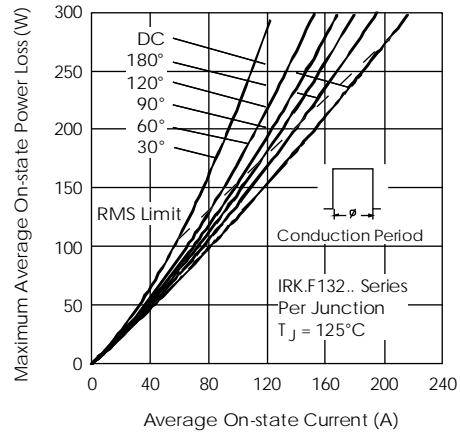


Fig. 4 - On-state Power Loss Characteristics

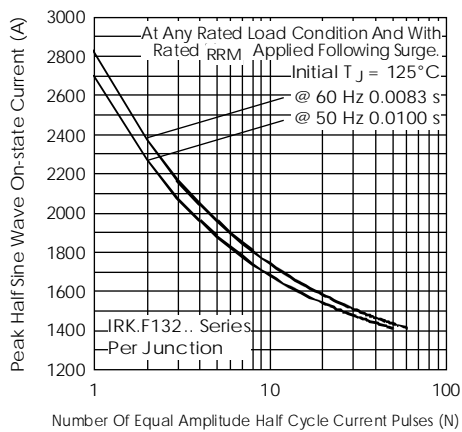


Fig. 5 - Maximum Non-Repetitive Surge Current

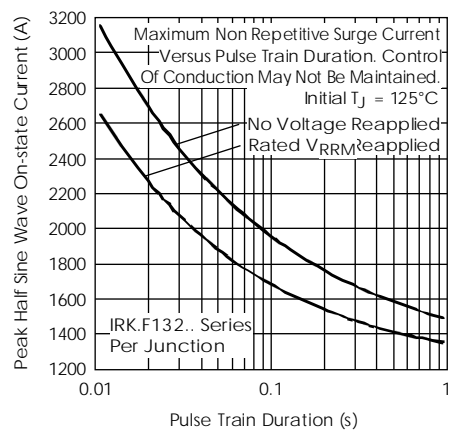


Fig. 6 - Maximum Non-Repetitive Surge Current

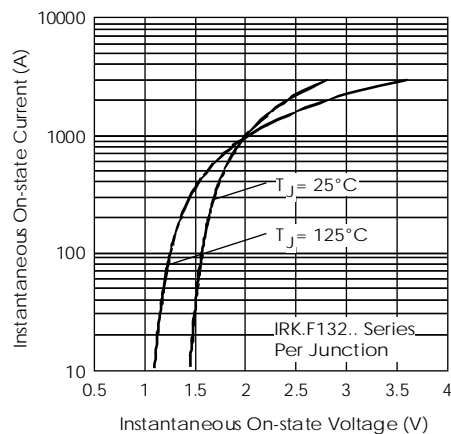


Fig. 7 - On-state Voltage Drop Characteristics

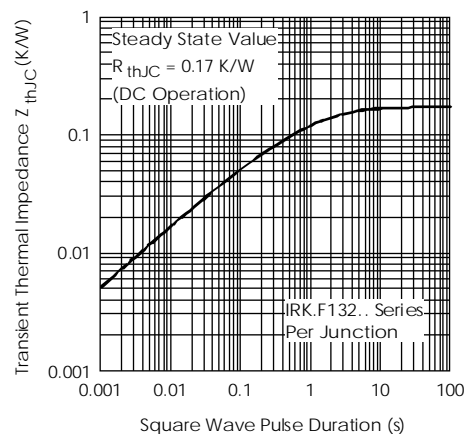


Fig. 8 - Thermal Impedance Z_{thJC} Characteristic

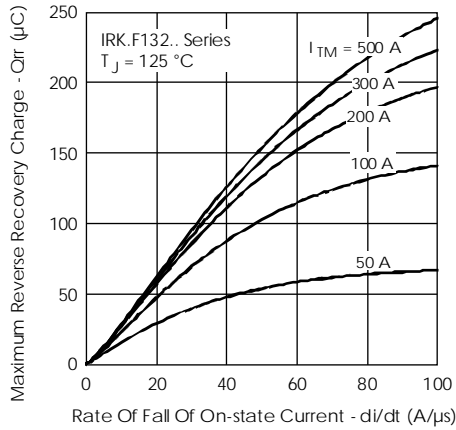


Fig. 9 - Reverse Recovery Charge Characteristics

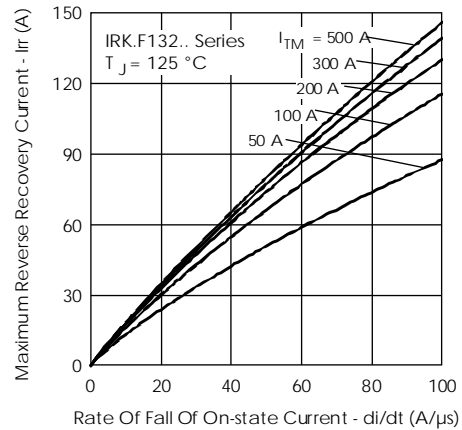


Fig. 10 - Reverse Recovery Current Characteristics

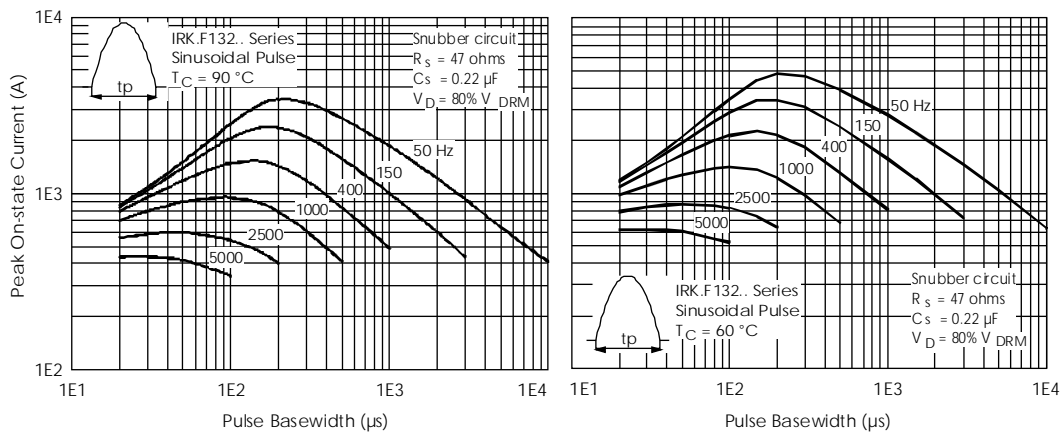


Fig. 11 - Frequency Characteristics

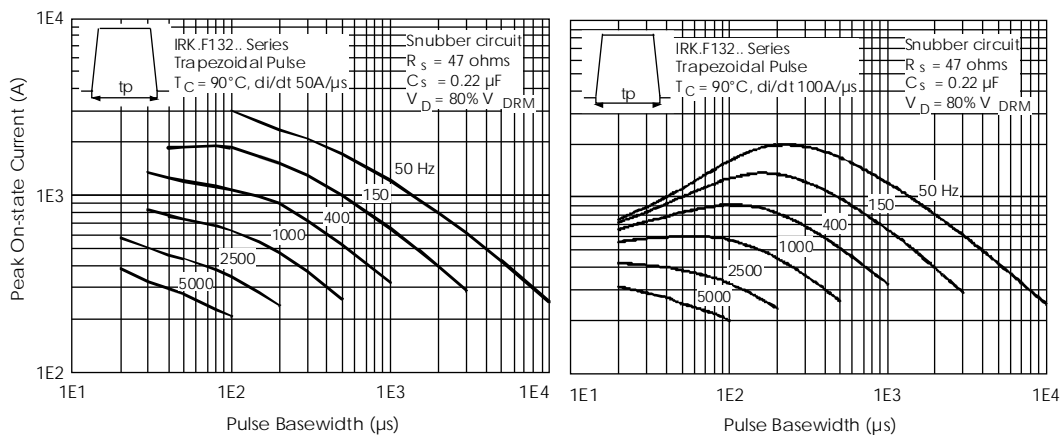


Fig. 12 - Frequency Characteristics

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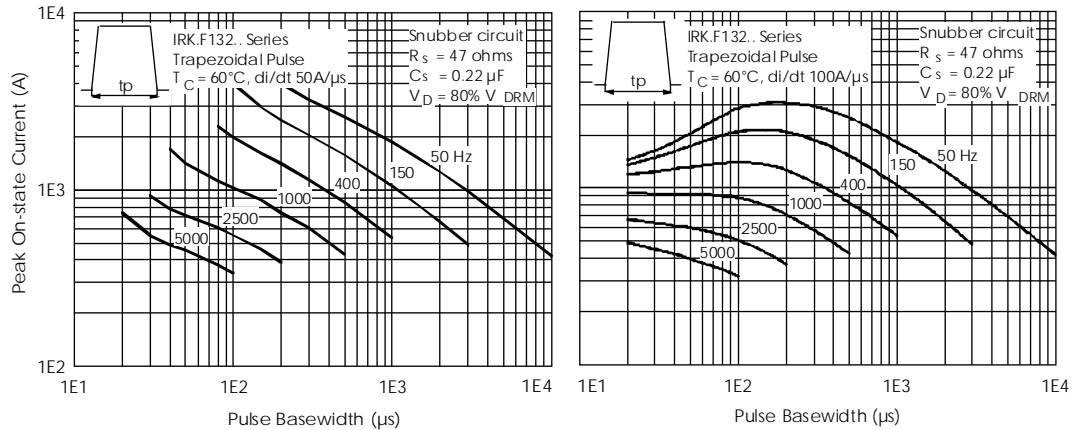


Fig. 13 - Frequency Characteristics

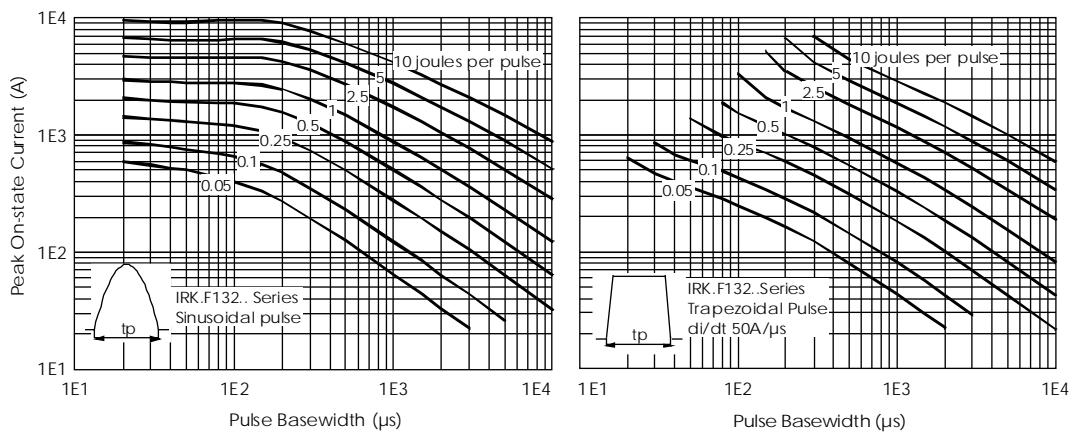


Fig. 14 - Maximum On-state Energy Power Loss Characteristics

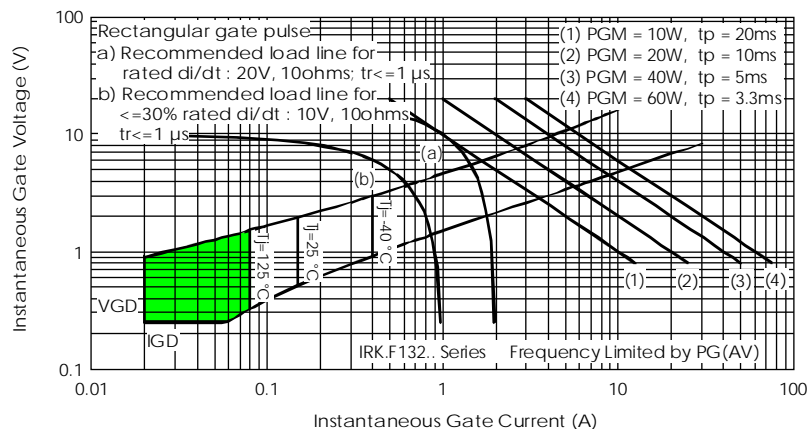


Fig. 15 - Gate Characteristics